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Ebihara et al.

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(54) **HYBRID INTEGRATED CIRCUIT DEVICE**

(75) Inventors: **Hitoshi Ebihara**; **Naoki Tomaru**; **Yoshiyuki Wasada**; **Tetsuya Ito**; **Hideki Kato**; **Tomohiro Igarashi**; **Hideki Yoda**, all of Tokyo (JP)

(73) Assignee: **Taiyo Yuden Co., Ltd.**, Tokyo (JP)

(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (7) Cl.** **13-03**
(52) **U.S. Cl.** **D13/182**
(58) **Field of Search** D13/182, 123, D13/133, 180, 184, 199; D10/46, 75; 29/829–932, 846; 174/250–251, 253–255, 260–261, 268; 216/13; 292/314; 316/718, 748, 752–753, 760, 783–784, 820; 411/500; 428/901; 470/27

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Primary Examiner—Ted Shooman
Assistant Examiner—Daniel Bui
(74) *Attorney, Agent, or Firm*—Bacon & Thomas

(57) **CLAIM**

The ornamental design for a hybrid integrated circuit device, as shown and described.

DESCRIPTION

FIG. **1** is a perspective view of a hybrid integrated circuit device showing an embodiment of our new design;

FIG. **2** is a front elevational view thereof;

FIG. **3** is a rear elevational view thereof;

FIG. **4** is a left side elevational view thereof;

FIG. **5** is a right side elevational view thereof;

FIG. **6** is a top plan view thereof; and,

FIG. **7** is a bottom plan view thereof.

1 Claim, 3 Drawing Sheets

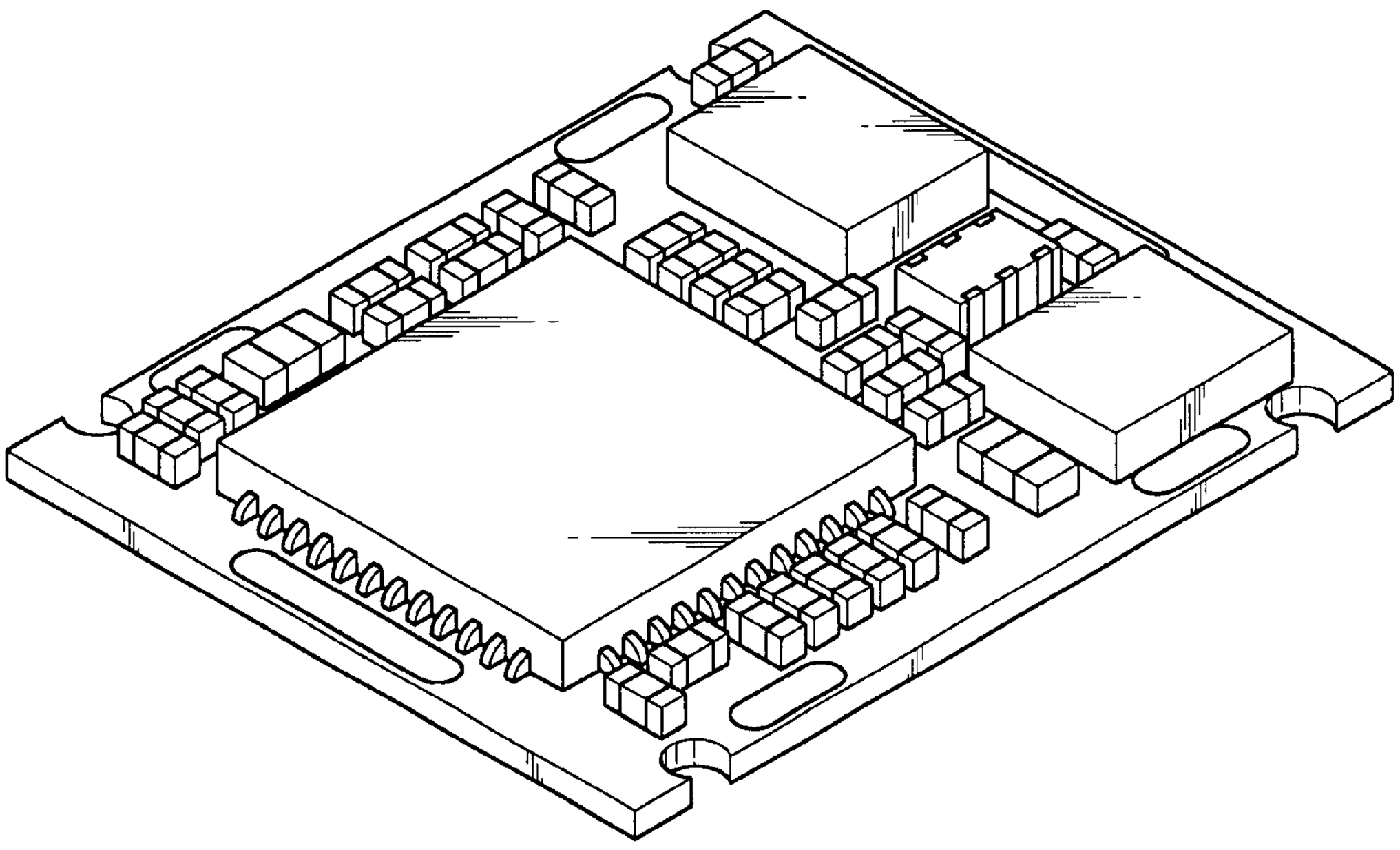

FIG. 1

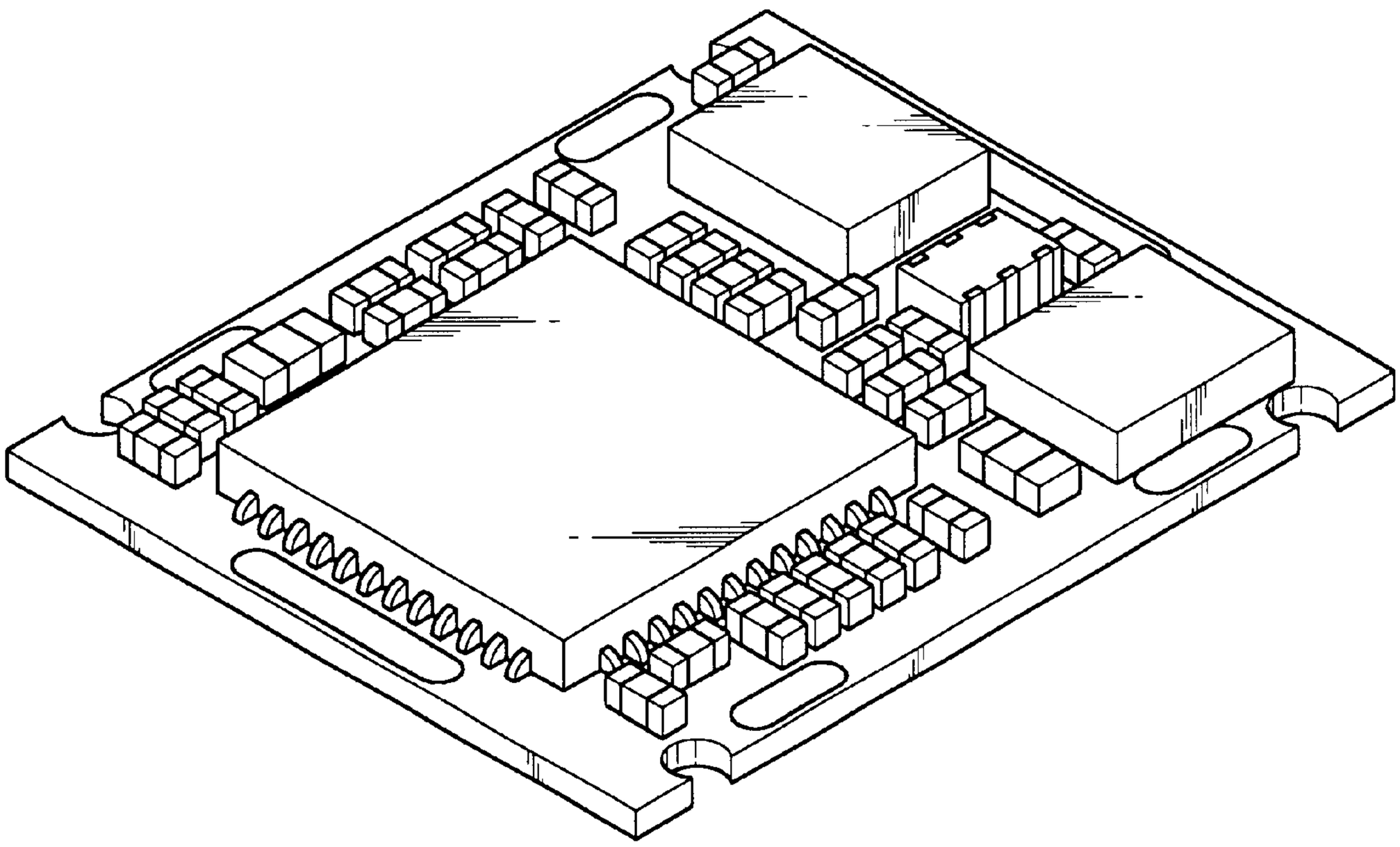

FIG.2

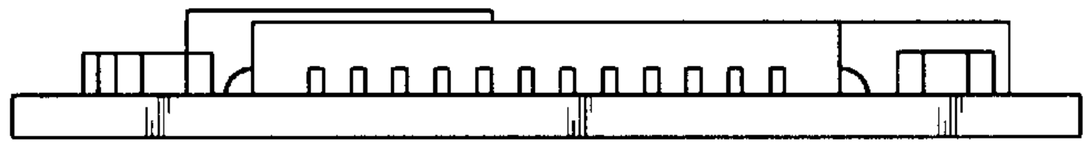

FIG.3

FIG.4

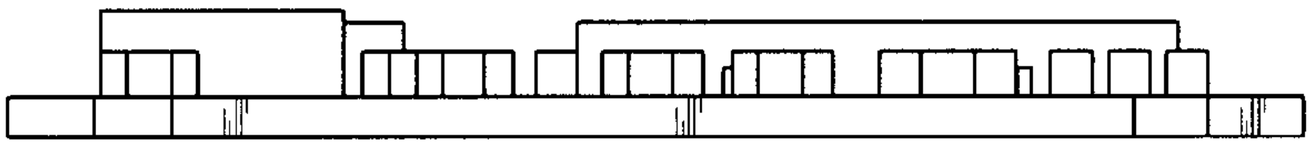

FIG.5

FIG. 6

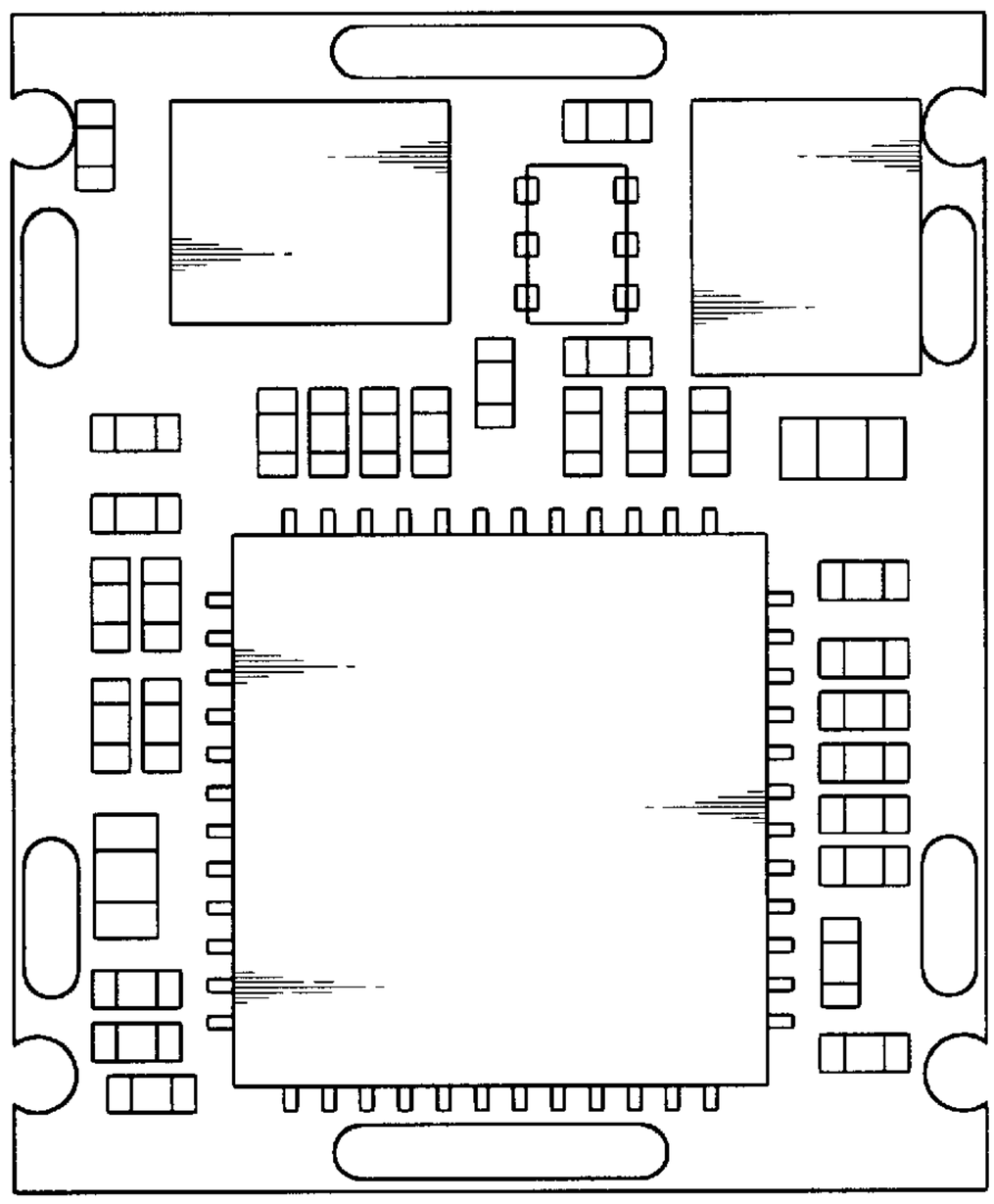

FIG. 7